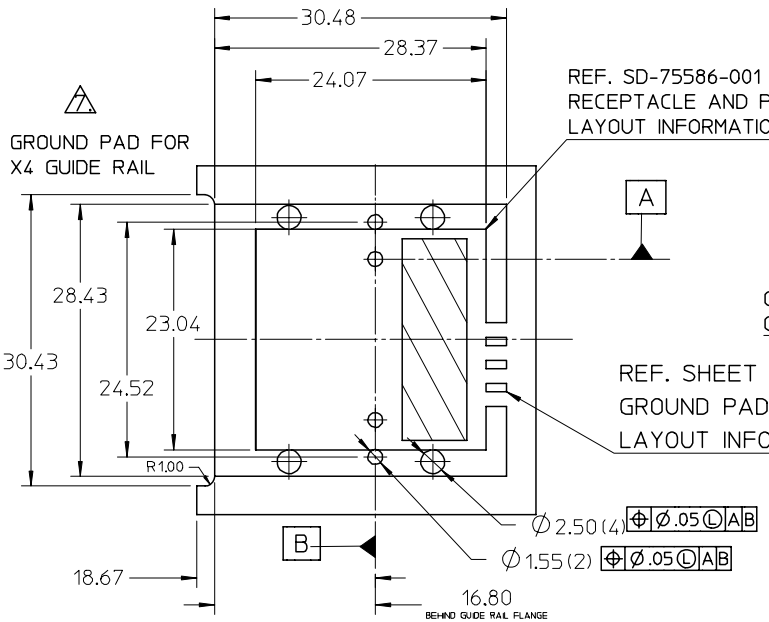
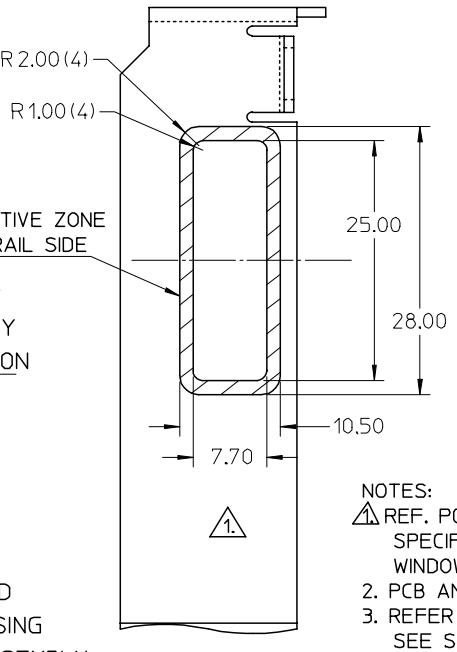
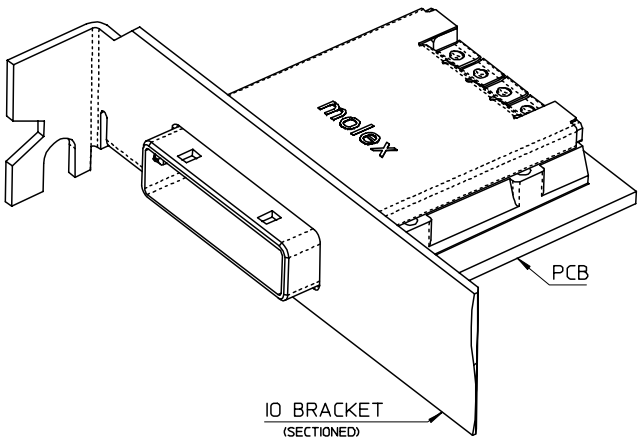
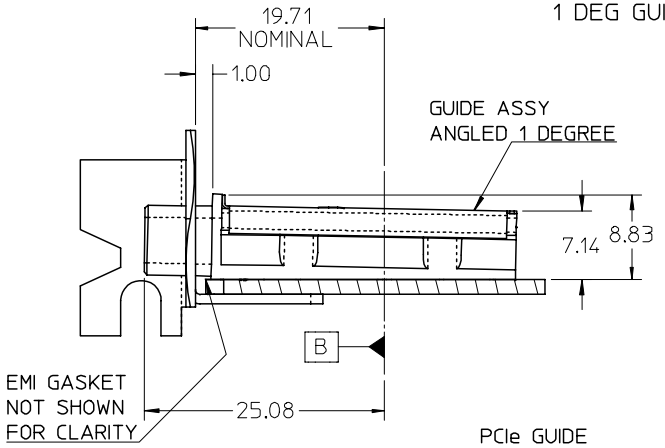




IO BRACKET
WINDOW



PCIe EXPANSION CARD
APPLICATION SHOWN USING
1 DEG GUIDE HOUSING ASSEMBLY



PCIe GUIDE
HOUSING ASSEMBLY

NOTES:
1. REF. PCI EXPRESS CARD ELECTROMECHANICAL SPECIFICATION, REV 1.0a FOR IO BRACKET WINDOW LOCATION.
2. PCB AND IO BRACKET SHOWN FOR REFERENCE ONLY.
3. REFER TO SHEET 2 FOR ATCA GUIDE HOUSING ASSEMBLY. SEE SHEET 3 FOR SCREEN LENGTH + TORQUE SPEC.
4. GUIDE HOUSING MOUNTING THREAD= M2 X 0.4
5. PCB NOTCH IS SHOWN FOR PCI COMPLIANT BOARD.
6. THIS PRODUCT MEETS THE RESTRICTION OF HAZARDOUS SUBSTANCES IN ELECTRICAL AND ELECTRONIC EQUIPMENT (RoHS) DIRECTIVE (2002/95/EC)
7. PLATE GROUND PAD WITH EMERSION SILVER OR GOLD.
8. MATES WITH MOLEX 4X CABLE SERIES 74546-040X.
9. GUIDE HOUSING PEGS FOR ALIGNMENT ONLY. "DO NOT SOLDER"

iPass™ is a trademark of Molex.

ENTER DESCRIPTION
EC NO: USY2007-0169 2006/11/08
DRWN:SNAVARRO 2006/11/13
CH'KD:BREED 2006/11/14
APPR:DDOYE
DESCRIPTION
REV G

QUALITY SYMBOLS
▼=0
▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± 0.05	± ---
1 PLACE	± 0.10	± ---
ANGULAR ±1/2°		

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: MM ONLY
SCALE: 2:1
DESIGN UNITS: METRIC
THIRD ANGLE PROJECTION

		DATE
DRAWN BY	BAREED	2005/02/03
CHECKED BY	DDOYE	2005/02/03
APPROVED BY	DDOYE	2005/02/03

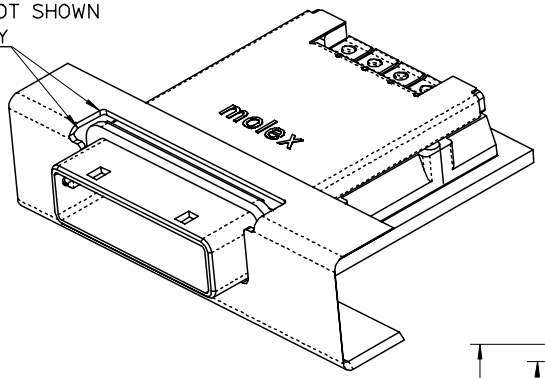
TITLE: IPASS X4 EMI GUIDE HOUSING ASSEMBLY

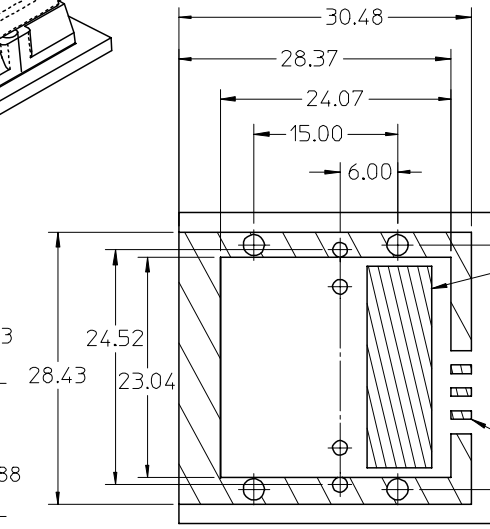
MOLEX INCORPORATED

MATERIAL NO.: SEE TABLE
DOCUMENT NO.: SD-74540-400
SHEET NO.: 1 OF 3
SIZE: B

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

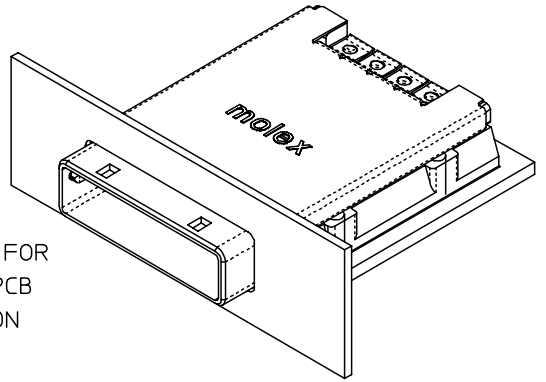
GASKETS NOT SHOWN FOR CLARITY

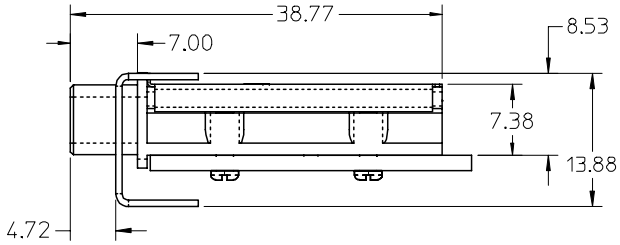


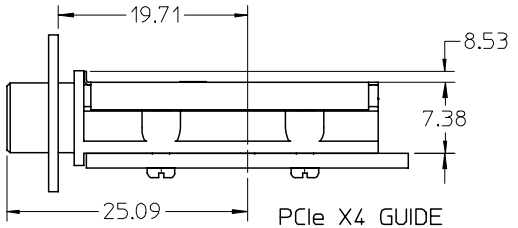


REF. SD-75586-001 FOR RECEPTACLE AND PCB LAYOUT INFORMATION

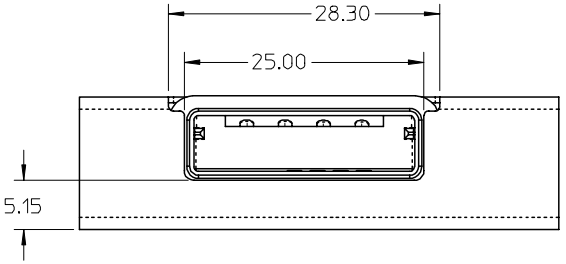
REF. SHEET 3 FOR GROUND PAD ALLEY LAYOUT INFORMATION







PCIe X4 GUIDE HOUSING ASSEMBLY



ADVANCED TCA APPLICATION
SHOWN USING 0 DEGREE
GUIDE HOUSING ASSEMBLY

STANDARD APPLICATION
SHOWN USING 0 DEGREE
GUIDE HOUSING ASSEMBLY

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ENTER DESCRIPTION
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CH'KD:BREED 2006/11/14
APPR:DDOYE
DESCRIPTION
REV
G

QUALITY SYMBOLS
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▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

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3 PLACES	± ---	± ---
2 PLACES	± 0.05	± ---
1 PLACE	± 0.10	± ---
ANGULAR ±1/2°		

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: MM ONLY
SCALE: 2:1
DESIGN UNITS: METRIC
THIRD ANGLE PROJECTION

DRAWN BY	BAREED	DATE 2005/02/03
CHECKED BY	DDOYE	DATE 2005/02/03
APPROVED BY	DDOYE	DATE 2005/02/03

TITLE
IPASS X4 EMI
GUIDE HOUSING ASSEMBLY

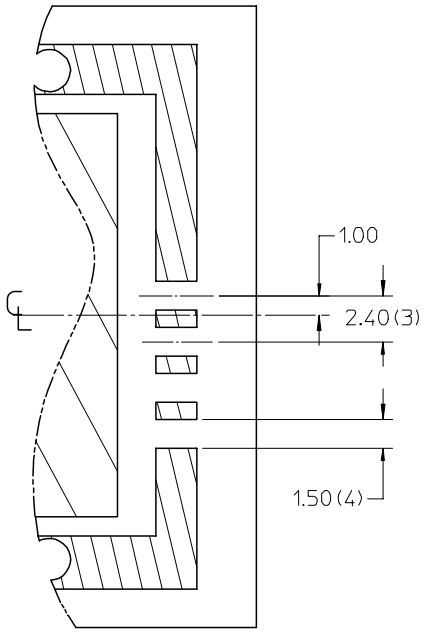
MOLEX INCORPORATED

MATERIAL NO. SEE TABLE
DOCUMENT NO. SD-74540-400
SHEET NO. 2 OF 3
SIZE B

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P/N	DESCRIPTION	GEN
745400400	4X EMI Guide Housing Assembly - PCIe / 1 Deg	Gen 1
745400500	4X EMI Guide Housing Assembly - ATCA / 0 Deg	Gen 1

PCB THICKNESS	SCREW LENGTH	TORQUE(IN LBS)
1.6 (.063")	5MM	2.3
2.38 (.093")	6MM	2.3
3.2 (.125")	6MM	2.3
	+4MM MAX	2.3



PARTIAL1
SCALE 4:1
GROUND PAD ALLEY
LAYOUT INFORMATION
7

ENTER DESCRIPTION
EC NO: USY2007-0169 2006/11/08
DRWN:SNAVARRO 2006/11/13
CH'KD:BREED
APPR:DDOYE 2006/11/14
DESCRIPTION
G
REV

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▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
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2 PLACES	± 0.05	± ---
1 PLACE	± 0.10	± ---
ANGULAR ±1/2°		

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: MM ONLY
SCALE: 1:1
DESIGN UNITS: METRIC
THIRD ANGLE PROJECTION

		DATE
DRAWN BY	BAREED	2005/02/03
CHECKED BY	DDOYE	2005/02/03
APPROVED BY	DDOYE	2005/02/03

TITLE
IPASS X4 EMI
GUIDE HOUSING ASSEMBLY

MOLEX INCORPORATED

MATERIAL NO.: SEE TABLE
DOCUMENT NO.: SD-74540-400
SHEET NO.: 3 OF 3
SIZE: B

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Общество с ограниченной ответственностью «МосЧип» ИНН 7719860671 / КПП 771901001
Адрес: 105318, г.Москва, ул.Щербаковская д.3, офис 1107

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

http://moschip.ru/get-element

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

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